

# **GNSS LOW NOISE AMPLIFIER**

#### **■ GENERAL DESCRIPTION**

The NJG1108HA8 is a low noise amplifier GaAs MMIC designed for GNSS (Global Navigation Satellite Systems). This amplifier provides low noise figure, high gain and high IP3 operated by single low positive power supply. This IC has the function of Stand-by mode. The NJG1108HA8 can be tuned to wide frequency from 1.5GHz to 2.7GHz by changing the external matching components.

An ultra-small and ultra-thin package of the USB6-A8 is adopted.

#### **■ PACKAGE OUTLINE**



**NJG1108HA8** 

#### **■ APPLICATIONS**

GNSS application, like GPS, Galileo, GLONASS and COMPASS W-LAN and WiMAX application

Note: Please check the Application Note for WLAN and WiMAX.

#### **■ FEATURES**

1.5~2.7GHz Operating frequency range Low voltage operation +2.7V tvp. Low current consumption 2.0mA typ. @V<sub>CTL</sub>=1.85V

@V<sub>CTL</sub>=0V 1uA typ. High gain 19dB typ. @V<sub>CTL</sub>=1.85V, f=1.575GHz

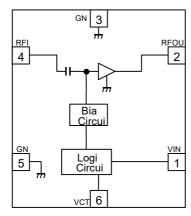
Low noise figure 1.0dB typ. @V<sub>CTL</sub>=1.85V, f=1.575GHz Input power at 1dB gain compression point -15.0dBm typ. @V<sub>CTL</sub>=1.85V, f=1.575GHz

 High input IP3 0dBm typ. @V<sub>CTL</sub>=1.85V, f=1.575+1.5751GHz Ultra-small and ultra-thin package

USB6-A8 (Package size: 1.0x1.2x0.38mm)

#### **■ PIN CONFIGURATION**

(Top View)



Pin Connection

- 1. VINV
- 2. RFOUT
- 3. GND
- 4. RFIN
- 5. GND
- 6. VCTL

## **TRUTH TABLE**

"H"=V<sub>CTL(H)</sub>, "L"=V<sub>CTL(L)</sub>

$V_{CTL}$	LNA Mode
Н	Active Mode
L	Sleep Mode

Note: Specifications and description listed in this datasheet are subject to change without notice.

# ■ABSOLUTE MAXIMUM RATINGS

 $T_a = +25$ °C,  $Z_s = Z_l = 50$ ohm

PARAMETER	SYMBOL	CONDITIONS	RATINGS	UNITS
Drain Voltage	$V_{DD}$		5.0	V
Inverter voltage	$V_{INV}$		5.0	V
Control voltage	V <sub>CTL</sub>		5.0	V
Input power	Pin	V <sub>DD</sub> =2.7V	+15	dBm
Power dissipation	$P_D$	On PCB board, Tjmax=150°C	150	mW
Operating temperature	$T_{opr}$		-40~+85	°C
Storage temperature	T <sub>stg</sub>		-55~+150	°C

#### **■**ELECTRICAL CHARACTERISTICS 1

GENERAL CONDITIONS: V<sub>DD</sub>=V<sub>INV</sub>=2.7V, T<sub>a</sub>=+25°C, Z<sub>s</sub>=Z<sub>I</sub>=500hm, with application circuit

GENERAL CONDITIONS. VDD-VNV-2.7 V, Ta-+25 C, Zs-Zi-5001111, With application circuit				ation circuit		
PARAMETERS	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating voltage	$V_{DD}$		2.5	2.7	3.5	V
Inverter supply voltage	$V_{INV}$		2.5	2.7	3.5	V
Control voltage (High)	V <sub>CTL</sub> (H)		1.5	1.85	V <sub>INV</sub> +0.3	V
Control voltage (Low)	V <sub>CTL</sub> (L)		0	0	0.3	V
Operating current1 (Active Mode, RF OFF)	I <sub>DD</sub> 1	RF OFF, V <sub>CTL</sub> =1.85V	-	2.0	3.0	mA
Operating current2 (Sleep Mode, RF OFF)	I <sub>DD</sub> 2	RF OFF, V <sub>CTL</sub> =0V	1	1	5	μΑ
Inverter current1	I <sub>INV</sub> 1	RF OFF, V <sub>CTL</sub> =1.85V	ı	30	60	μΑ
Inverter current2	I <sub>INV</sub> 2	RF OFF, V <sub>CTL</sub> =0V	-	9	20	μΑ
Control current	Ість	RF OFF, V <sub>CTL</sub> =1.85V	-	6	20	μA

# ■ELECTRICAL CHARACTERISTICS 2 (Active Mode) GENERAL CONDITIONS: Vpp=Vpv=2.7V, Vcti = 1.85V, fr=1575MHz, Ta=+25°C, Zs=Zi=50ohm, with application circuit

GENERAL CONDITIONS: V <sub>DD</sub> =V <sub>INV</sub> =2.7V, V <sub>CTL</sub> =1.85V, f <sub>RF</sub> =1575MHz, I <sub>a</sub> =+25°C, Z <sub>s</sub> =Z <sub>I</sub> =500hm, with application circuit						
PARAMETERS	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Frequency	freq		1.57	1.575	1.58	GHz
Small signal gain	Gain		17.0	19.0	21.5	dB
Noise figure	NF	Exclude PCB & connector losses (IN: 0.05dB)	-	1.0	1.2	dB
Input power at 1dB gain compression point	P <sub>-1dB(IN)</sub>		-19.0	-15.0	-	dBm
Input 3rd order intercept point	IIP3	f1=f <sub>RF</sub> , f2=f <sub>RF</sub> +100kHz, Pin=-34dBm	-5.0	0	-	dBm
RF IN VSWR	VSWRi		-	2.0	2.5	
RF OUT VSWR	VSWRo		-	1.5	2.0	

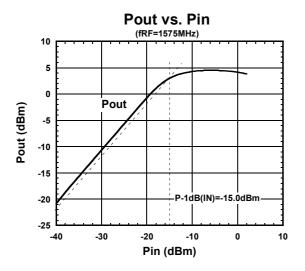
# **■**TERMINAL INFORMATION

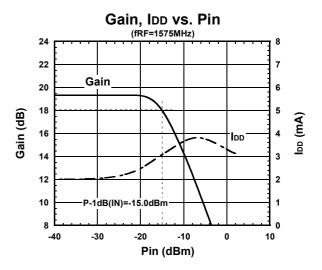
No.	SYMBOL	DESCRIPTION		
1	VINV	Power supply pin of the inverter circuit.		
2	RFOUT	RF Output and voltage supply pin. External matching circuits and a bypass capacitor is required. L3 is a RF choke inductor. These elements are used as output matching circuit.		
3	GND	Ground pin. To keep good RF grounding performance, please use multiple via holes to connect with ground plane and this pin.)		
4	RFIN	RF input pin. A DC blocking capacitor is not required. An external matching circuit is required.		
5	GND	Ground pin. To keep good RF grounding performance, please use multiple via holes to connect with ground plane and this pin.)		
6	VCTL	Control voltage input pin. This control pin is set to high. LNA suffers from standby state when LNA puts the changeover voltage of "Low" in a state of movement when the changeover voltage of "High" is put in this terminal.		

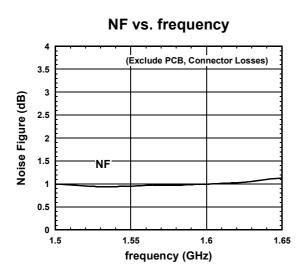
# **CAUTION**

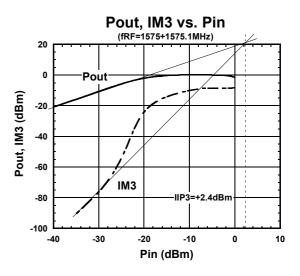
1) Ground terminal (3, 5) should be connected to the ground plane as low inductance as possible.

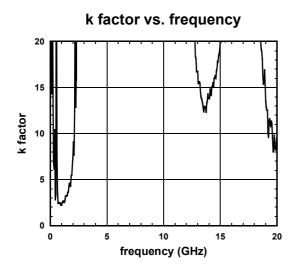
(Conditions: V<sub>DD</sub>=V<sub>INV</sub>=2.7V, V<sub>CTL</sub>=1.85V, f<sub>RF</sub>=1575MHz, T<sub>a</sub>=+25°C, Z<sub>s</sub>=Z<sub>I</sub>=50ohm, with application circuit)



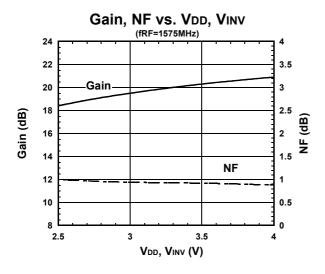


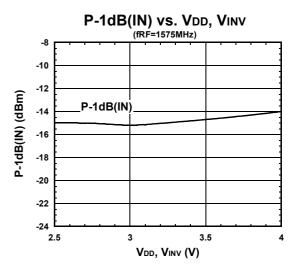


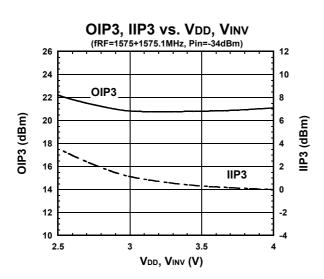


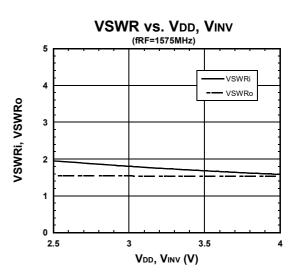


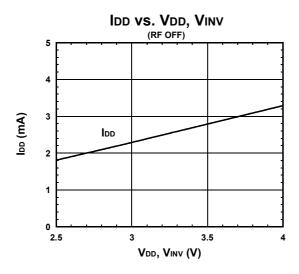
(Conditions: V<sub>DD</sub>=V<sub>INV</sub>=2.7V, V<sub>CTL</sub>=1.85V, f<sub>RF</sub>=1575MHz, T<sub>a</sub>=+25°C, Z<sub>s</sub>=Z<sub>I</sub>=50ohm, with application circuit)











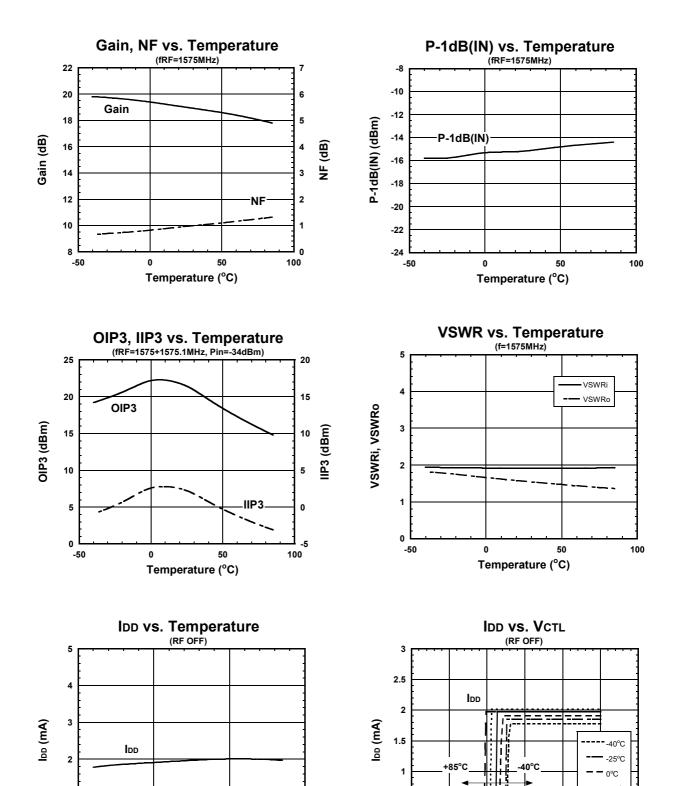
1

0

-50

Temperature (°C)

(Conditions: V<sub>DD</sub>=V<sub>INV</sub>=2.7V, V<sub>CTL</sub>=1.85V, f<sub>RF</sub>=1575MHz, T<sub>a</sub>=+25°C, Z<sub>s</sub>=Z<sub>I</sub>=50ohm, with application circuit)



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0.5

0

0

0.5

1.5

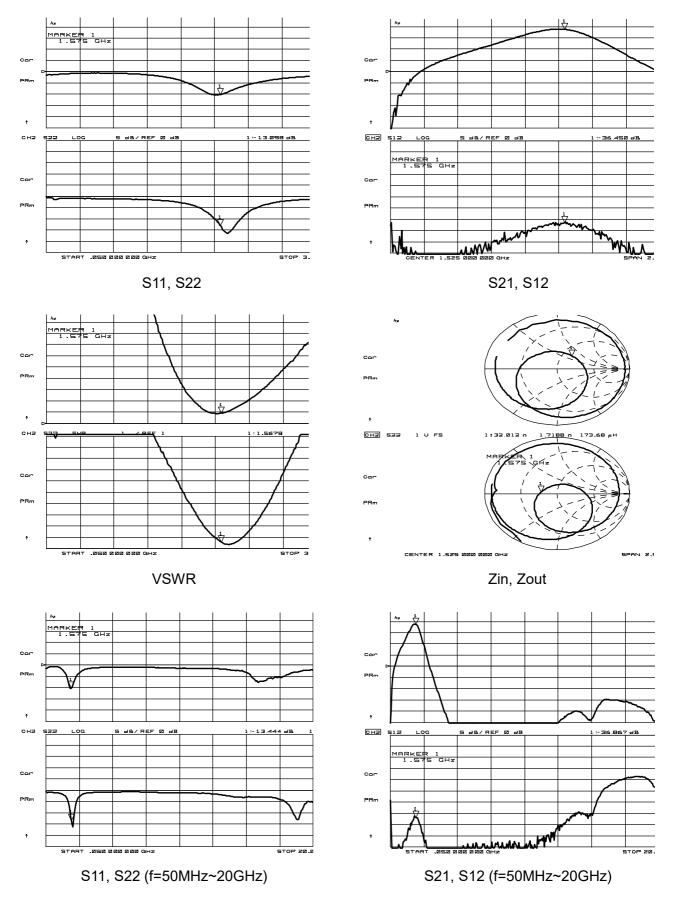
Vctl (V)

1

+50°C +85°C

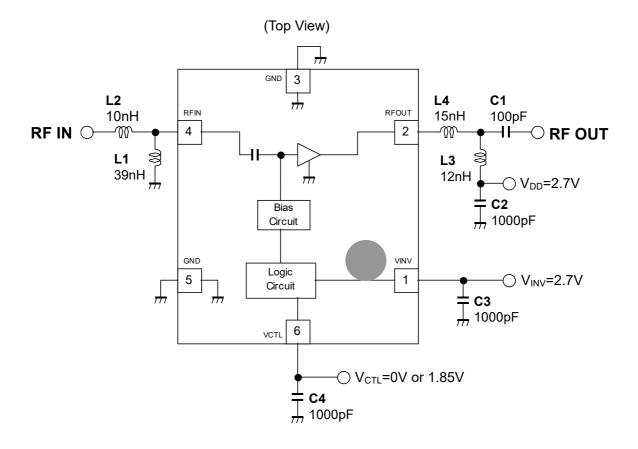
2.5

(Conditions: V<sub>DD</sub>=V<sub>INV</sub>=2.7V, V<sub>CTL</sub>=1.85V, f<sub>RF</sub>=1575MHz, T<sub>a</sub>=+25°C, Z<sub>s</sub>=Z<sub>I</sub>=50ohm, with application circuit)

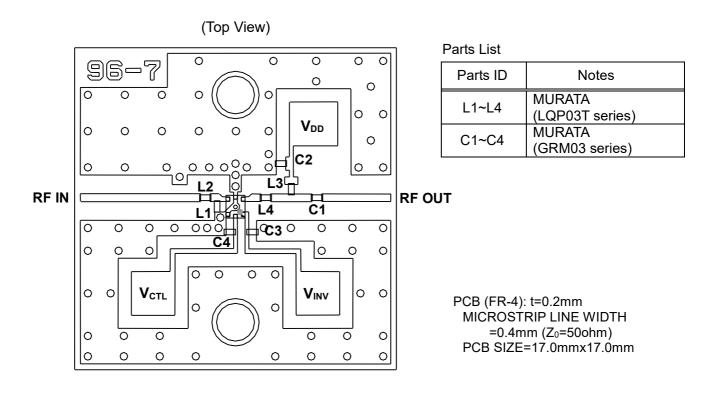


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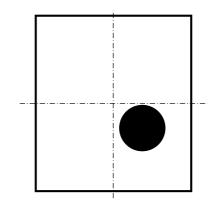
#### **■ APPLICATION CIRCUIT**

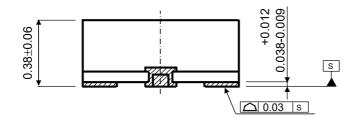


### **■ TEST PCB LAYOUT**



# **■PACKAGE OUTLINE** (USB6-A8)

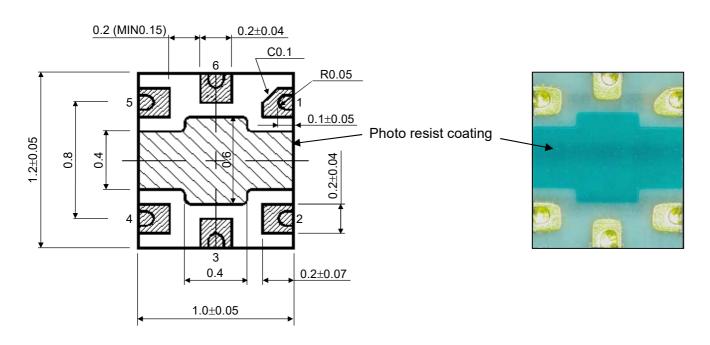




**TERMINAL TREAT** :Au :FR5 Substrate

:Epoxy resin Molding material

**UNIT** :mm WEIGHT :1.1mg



#### Cautions on using this product

This product contains Gallium-Arsenide (GaAs) which is a harmful material.

- Do NOT eat or put into mouth.
- Do NOT dispose in fire or break up this product.
- Do NOT chemically make gas or powder with this product.
- To waste this product, please obey the relating law of your country.

This product may be damaged with electric static discharge (ESD) or spike voltage. Please handle with care to avoid these damages.

The specifications on this databook are only given for information , without any guarantee as regards either mistakes or omissions. The application circuits in this databook are described only to show representative usages of the product and not intended for the guarantee or permission of any right including the industrial rights.

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- 8. Quality Warranty
  - 8-1. Quality Warranty Period
    - In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
  - 8-2. Quality Warranty Remedies
    - When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.
    - Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
  - 8-3. Remedies after Quality Warranty Period
    - With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
- 9. Anti-radiation design is not implemented in the products described in this document.
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- 11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
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Official website

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